COMPLIANT

HALOGEN

FREE





N-Channel Reduced Q_g , Fast Switching MOSFET

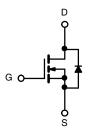
PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
30	0.0032 at V _{GS} = 10 V	25			
30	0.0036 at $V_{GS} = 4.5 \text{ V}$	22			

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Extremely Low Q_{gd} for Switching Losses Improvement
- TrenchFET® Gen II Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Low-Side DC/DC Conversion
 - Notebook, Server, VRM Module
- Fixed Telecom



N-Channel MOSFET

	SO-8		
S 1 S 2 S 3 G 4		8 7 6 5	D D D
	Top View		

Ordering Information: Si4368DY-T1-E3 (Lead (Pb)-free)

Si4368DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	30		V	
Gate-Source Voltage		V _{GS}	± 12		V	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	- I _D	25	17		
Continuous Diain Current (1 j = 150 °C)	T _A = 70 °C		20	13		
Pulsed Drain Current (10 μs Pulse Width)		I _{DM}	70		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	2.9	1.3		
Avalanch Current	L = 0.1 mH	I _{AS}	50			
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	3.5	1.6	W	
Maximum Fower Dissipation	T _A = 70 °C	L D	2.2	1	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	В	29	35		
Maximum Junction-to-Ambient	Steady State	R_{thJA}	67	80	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	13	16	1	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

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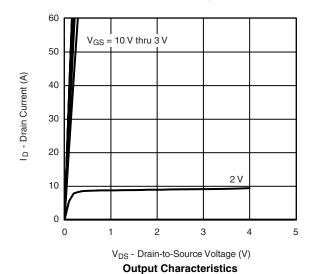
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6		1.8	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zoro Coto Voltogo Droin Current	1	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}				5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
Drain-Source On-State Resistance ^a		$V_{GS} = 10 \text{ V}, I_D = 25 \text{ A}$ 0.0		0.0026	0.0032	Ω	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 22 \text{ A}$		0.0029	0.0036	22	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 25 A		150		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 2.9 A, V _{GS} = 0 V		0.66	1.1	V	
Dynamic ^b							
Input Capacitance	C _{iss}			8340			
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		850		pF	
Reverse Transfer Capacitance	C _{rss}			355			
Total Gate Charge	Q_g			53	80		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		17.5		nC	
Gate-Drain Charge	Q_{gd}			6.5			
Gate Resistance	R_{g}	f = 1 MHz	0.8	1.2	1.8	Ω	
Turn-On Delay Time	t _{d(on)}			25	38		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		20	30	1	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1$ A, $V_{GEN} = 10$ V, $R_g = 6 \Omega$		172	260	ns	
Fall Time	t _f			41	62		
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = 2.9 \text{ A}, dI/dt = 100 \text{ A/}\mu\text{s}$		42	60		

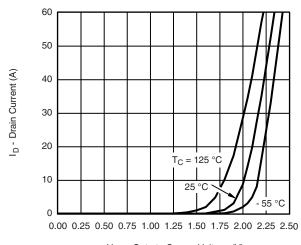
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



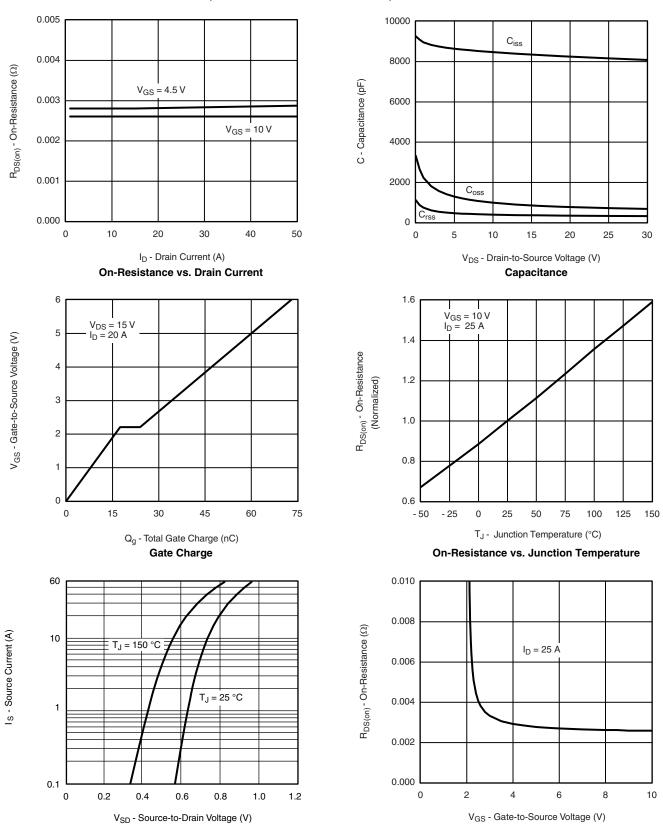


V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



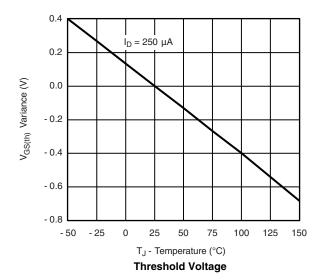
Source-Drain Diode Forward Voltage

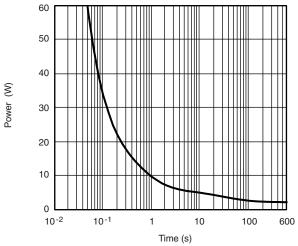
On-Resistance vs. Gate-to-Source Voltage

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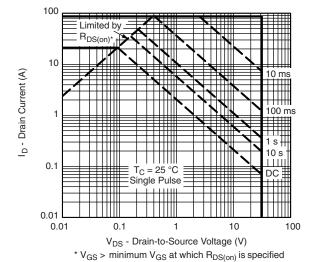
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

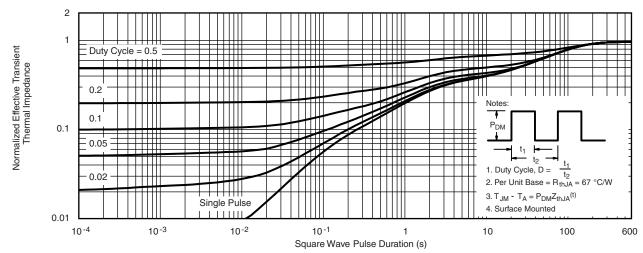




Single Pulse Power



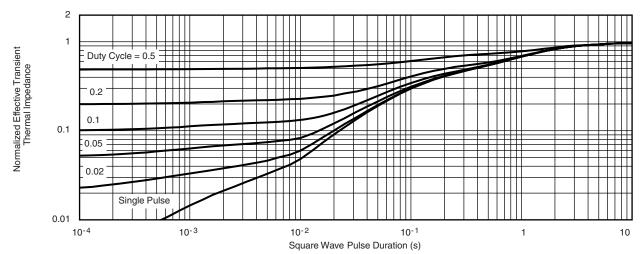
Safe Operating Area, Junction-to-Case







TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?72704.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
FCN: C-06527-Bey L 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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